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# Status of Investigations on Beetle1.2 and Steps Towards Beetle1.3

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Status of Investigations on Beetle1.2 and Steps Towards Beetle1.3



- Sticky Charge Effect
- 80 MHz Cross Talk
- Sagging Readout Baseline
- Modifications to the Comparator
- Chip size
- Further Issues





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- signal carry-over from previous event into an empty event, strong baseline drift
- only present for consecutive readouts, i.e. during a readout operation a further trigger arives



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## Sticky Charge Effect (2): Laser Patch

- polyamide/nitride/oxide window has been opened using UV-laser
- probe-needle has been positioned onto the reset line of pipeamp (ROAmpReset)
- external signal has been superimposed to the internal signal pulse
- phase of the external reset pulse relative to the clock has been varied





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## **Sticky Charge Effect (3): Simulations**





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## **Sticky Charge Effect (3): Simulations**



#### Modification in Beetle1.3: analog delay of MuxTrack by 5 ns.

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### **Sticky Charge Effect (4)**

### probe needle test with pos. and neg. phase shift



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## 80 MHz X-talk

cross talk with a frequency	spectrum of 8	80 MHz
present on digital signals, e.g. Data analogue signals, e.g. Ar power supply lines: Vddo	/alid nalogOut I, Vdda	
comparison:	Beetle1.1	Beetle1.2
# flip-flops:	1349	3043
# clock buffers:	21	284
guard rings logic core:	analogue	digital
F	Possible solution	ons:

reduced no. of clock buffers on-chip power blocking









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### **Readout Baseline Variation**





#### *LHCb* ГНСр

LHCb Week

### **Comparator Changes**

### Motivation: offset–spread: $\sigma$ = 2.4 DAC units = 300 nA = 0.2 MIP

- bipolar
- too large for compensation with present DACs for channel threshold

#### Measures:

- merging input buffers: reduces additional offset
- gain increase of buffer: reduces influence on offset
- increase resolution of threshold current to 5 bits required: ±900 nA = ±0.6 MIP



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## **Chip Size**

- Beetle1.0/1.1: (5.4 x 6.1) mm2
- Beetle1.2: (5.1 x 6.1) mm2 modified layout of protection diodes of analogue input pads
- Beetle1.3: (5.3...4 x 6.1) mm2
  comparator resolution increases by 2 bits
  additional power lines for shaper

#### enlargement of chip size

- is limited to one dimension
- only affects position of analogue input pads







- DACs: Radiation Hardness
- Test Pulse Generation
- Overvoltage Problem
- Corner Simulation





### **Stress Test on Beetle1.2**

reported on Beetle Review in January 2003: problem of Beetle1.2 @ Vdd > 2.5 V (2.6...2.7 V)



#### Solved !

- high bias current of output buffer (lcurrbuf) generates destructive current density
- increasing receiver series resistance allows reduction of lcurrbuf at the same output gain

stress test on Beetle1.2 @ Icurrbuf = 100 uA: 12 hours @ 3.3 V without problems

#### in Beetle1.3: limitation of current density in output buffer





### **Modifications in Beetle1.3**

5 V compatible I2C–Pads
analogue delay of MuxTrack signal: fix of sticky charge effect
improved comparator: 5 bit threshold resolution; increases chip length by 100 um!
improved shaper power routing: increases chip length by 100 um!
improved pipeamp power routing (already on Beetle12MA0)
separation of power supply of multiplexer and logic core
separation of comparator LVDS pad power
modified front–end power pads (power and ground at top and bottom of chip)
introduction of bias generator probe pad
modified test pulse pattern: uniform amplitude
merged pad openings of adjacent power pads
on–chip power blocking
limitation of current density in output buffer (to avoid overvoltage problem)
fix of daisy chain bug
fix of Rclk–divider bug: re–synthesis + place and route

doneunder workto be done

